



In the United States Patent and Trademark Office

In re the application of
Lee D. Whetsel

TI-25300.1

Serial No.: 09/745,523

Art Unit: 2829

Filed: 12/21/2000

Examiner: V. Nguyen

Title: Probeless Testing of Pad Buffers on Wafer

Amendment A Under 37 CFR 1.111

September 17, 2003

Asst. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)
I hereby certify that the above correspondence is
being deposited with the U.S. Postal Service as
First Class Mail in an envelope addressed to:
Assistant Commissioner For Patents, P.O. Box 1450,
Alexandria, VA 22313-1450 on September 17, 2003.

Lawrence J. Bassuk
Lawrence J. Bassuk, Reg. No. 29,043

Responsive to the Examiner's Action of 05/22/2003, please
amend this application as follows:

In the Title:

Amend the title to read as follows:

--Measuring On-Resistance Of An Output Buffer With
Terminals--

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